

STGW45HF60WDI

45 A, 600 V ultra fast IGBT

Preliminary data

Features

- Improved E_{off} at elevated temperature
- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)
- Low V_F soft recovery antiparallel diode

Applications

- Welding
- Induction heating
- Resonant converters

Description

The "HF" series is based on a new planar technology concept to yield an IGBT with tighter variation of switching energy (E_{off}) versus temperature. Suffix "W" denotes a subset of products tailored to high switching frequency operation over 100 kHz.

TO-247

Figure 1. Internal schematic diagram

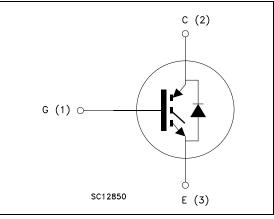


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW45HF60WDI	GW45HF60WDI	TO-247	Tube
STGWA45HF60WDI	45HF60WDI	TO-247 long leads	Tube

August 2009

Doc ID 16091 Rev 1

This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice.

1 Electrical ratings

Cumbal	Deventer		Value	l lacit
Symbol	Parameter	TO-247	TO-247 long leads	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	600		V
I _C ⁽¹⁾	Continuous collector current at $T_C = 25 \ ^{\circ}C$	70	80	А
I _C ⁽¹⁾	Continuous collector current at T _C = 100 °C	45	50	А
I _{CL} ⁽²⁾	Turn-off latching current		TBD	Α
I _{CP} ⁽³⁾	Pulsed collector current	TBD		А
V_{GE}	Gate-emitter voltage		± 20	V
١ _F	Diode RMS forward current at $T_C = 25 \ ^{\circ}C$		30	Α
I _{FSM}	Surge not repetitive forward current t _p = 10 ms sinusoidal	130		А
P _{TOT}	Total dissipation at $T_{C} = 25 \ ^{\circ}C$	250	310	W
T _{stg}	Storage temperature		55 to 150	°C
Тj	Operating junction temperature	-	55 to 150	C

Table 2.Absolute maximum ratings

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

2. Pulse width limited by maximum junction temperature and turn-off within RBSOA

3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_{G} = 10 $\Omega,\,T_{J}$ = 150 $^{\circ}C$

Symbol	Parameter		Value	Unit
Symbol	Parameter	TO-247	TO-247 long leads	Unit
D	Thermal resistance junction-case IGBT	0.5	0.4	°C/W
R _{thj-case}	Thermal resistance junction-case diode		1.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient		50	°C/W



2 Electrical characteristics

(T_J = 25 °C unless otherwise specified)

Table 4.	Static
1abie 4.	Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 30 A V _{GE} = 15V, I _C = 30 A,T _J = 125 °C		1.9 TBD	2.5	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1 \text{ mA}$	3.75		5.75	V
I _{CES}	Collector cut-off current $(V_{GE} = 0)$	V _{CE} = 600 V V _{CE} = 600 V, T _J = 125 °C			500 5	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			± 100	nA
9 _{fs}	Forward transconductance	V _{CE} = 15 V _, I _C = 30 A		TBD		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0	-	TBD TBD TBD	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390 V, I _C = 30 A, V_{GE} = 15 V, <i>Figure 3</i>	-	TBD TBD TBD	-	nC nC nC



Table 0.	Switching on/on (inductive load)					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 390 \ V, \ I_C = 30 \ A \\ R_{G} = 4.7 \ \Omega, \ V_{GE} = 15 \ V, \\ \hline \textit{Figure 2} \end{array}$	-	TBD TBD TBD	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, \text{ I}_{C} = 30 \text{ A}$ $R_{G} = 4.7 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 \text{ °C}$ Figure 2	-	TBD TBD TBD	-	ns ns A/µs
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, \text{ I}_{C} = 30 \text{ A},$ $R_{GE} = 4.7 \Omega, V_{GE} = 15 \text{ V}$ Figure 2	-	TBD TBD TBD	-	ns ns ns
t _r (V _{off}) t _{d(off}) t _f	Off voltage rise time Turn-off delay time Current fall time	V _{CC} = 390 V, I _C = 30 A, R _{GE} = 4.7 Ω, V _{GE} =15 V, T _J = 125 °C <i>Figure 2</i>	-	TBD TBD TBD	-	ns ns ns

 Table 6.
 Switching on/off (inductive load)

 Table 7.
 Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{off}	Turn-off switching losses	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 390 \; V, \; I_{C} = 30 \; A \\ R_{G} = 4.7 \; \Omega, \; V_{GE} = 15 \; V, \\ \hline \textit{Figure 4} \end{array}$	-	330		μJ
E _{off}	Turn-off switching losses		-	550	800	μJ

 Table 8.
 Collector-emitter diode

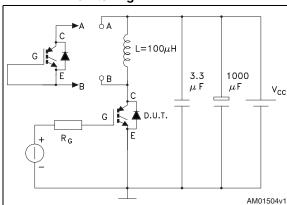
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 30 A I _F = 30 A, T _J = 125 °C	-	1.4 1.2	1.8	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _F = 30 A,V _R = 50 V, di/dt = 100 A/μs <i>Figure 5</i>	-	TBD TBD TBD	-	ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _F = 30 A,V _R = 50 V, T _J =125 °C, di/dt = 100 A/μs <i>Figure 5</i>	-	TBD TBD TBD	-	ns nC A



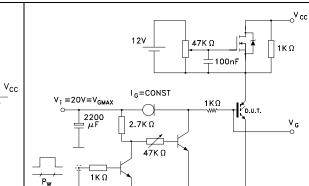
Figure 4.

AM01505v1

3 Test circuits



Switching waveform



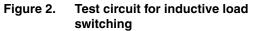
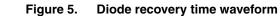
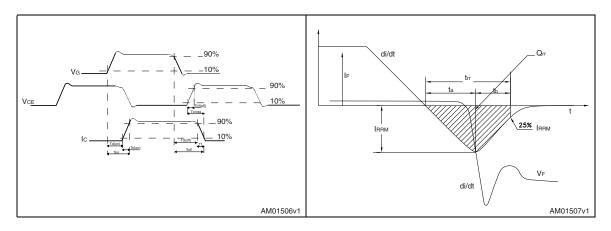


Figure 3. Gate charge test circuit







4 Package mechanical data

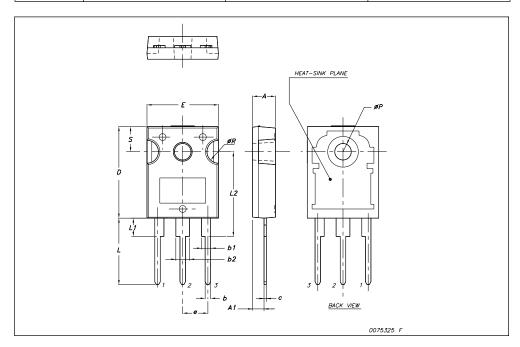
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



Γ

٦

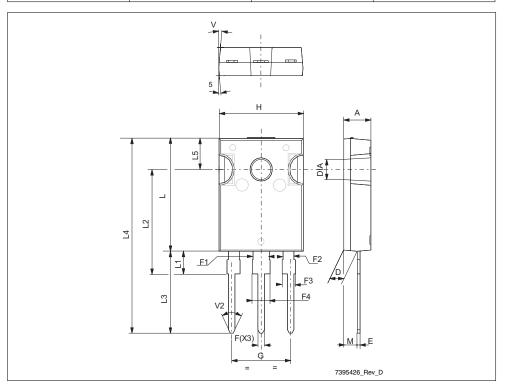
	TO-247 Mechanical data				
Dim.		mm.			
	Min.	Тур	Max.		
А	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
Е	15.45		15.75		
е		5.45			
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
øР	3.55		3.65		
øR	4.50		5.50		
S		5.50			





Γ

TO-247 long leads mechanical data			
Dim.		mm	
Dini.	Min.	Тур.	Max.
А	4.85		5.16
D	2.2		2.6
E	0.4		0.8
F	1		1.4
F1		3	
F2		2	
F3	1.9		2.4
F4	3		3.4
G		10.9	
Н	15.45		16.03
L	19.85		21.09
L1	3.7		4.3
L2	18.3		19.13
L3	14.2		20.3
L4	34.05		41.38
L5	5.35		6.3
М	2		3
V		5°	
V2		60°	
DIAM	3.55		3.65





5 Revision history

Table 9.Document revision history

Date	Revision	Changes
04-Aug-2009	1	Initial release.



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2009 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

10/10

